**NXPSC16650B** 



#### **Product data sheet**

## **1. General description**

WeEn Sem

Silicon Carbide Schottky diode in a TO263 (D2PAK) plastic package, designed for high frequency switched-mode power supplies.



### 2. Features and benefits

- · Highly stable switching performance
- High forward surge capability I<sub>FSM</sub>
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

## 3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

## 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values				Unit
Absolute	maximum rating						
V <sub>RRM</sub> repetitive peak reverse 650 V voltage						V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T <sub>mb</sub> ≤ 105 °C; Fig. 1; Fig. 2; Fig. 3	16		A		
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V <sub>F</sub> forward voltage		I <sub>F</sub> = 16 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.5	1.7	V
		I <sub>F</sub> = 16 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.8	2.1	V

# **5. Pinning information**

Table 2.	able 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	n.c.	not connected						
2	К	cathode [1]		K <u> </u>				
3	А	anode						
mb	К	mounting base; connected to cathode						

[1] It is not possible to connect to pin 2 of the TO263 package.

# 6. Ordering information

Table 3. Ordering information								
	Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
	NXPSC16650B	TO263	NXPSC16650B6J	Reel	800	TO263N	26-Sep-2016	

# 7. Marking

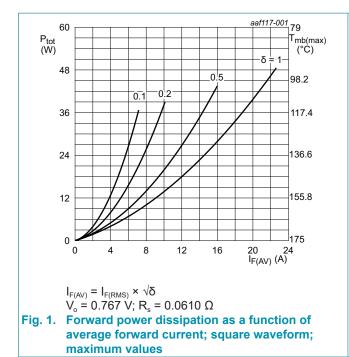
Table 4. Marking codes						
Type number	Marking codes					
NXPSC16650B	NXPSC 16650B					

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
$V_{\text{RRM}}$	repetitive peak reverse voltage		650	V
$V_{\text{RWM}}$	crest working reverse voltage		650	V
V <sub>R</sub>	reverse voltage	DC	650	V
I <sub>F(AV)</sub>	average forward current	δ = 0.5; square-wave pulse; T <sub>mb</sub> ≤ 105 °C; Fig. 1; Fig. 2; Fig. 3	16	A
I <sub>FRM</sub>	repetitive peak forward current	δ = 0.5; t <sub>p</sub> = 25 μs; T <sub>mb</sub> ≤ 105 °C; square-wave pulse	32	A
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	96	A
	forward current	$t_p$ = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse	770	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms	46	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature		-55 to 175	°C
T <sub>j</sub>	junction temperature		175	°C



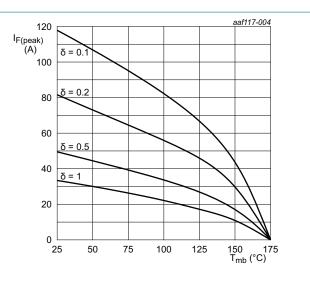


Fig. 2. Current derating as a function of mounting base temperature

### **WeEn Semiconductors**

## NXPSC16650B Silicon Carbide Diode

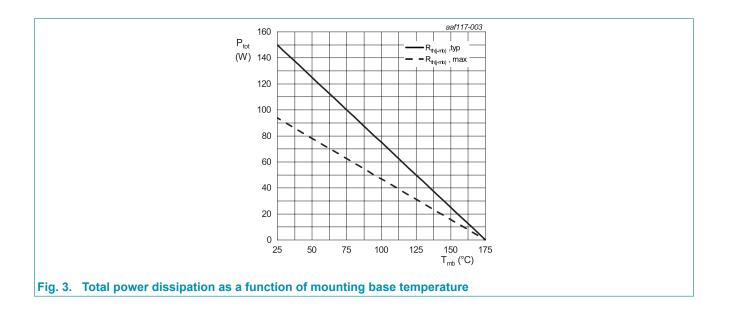
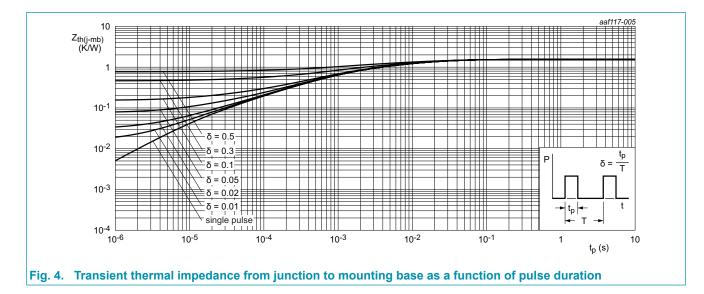


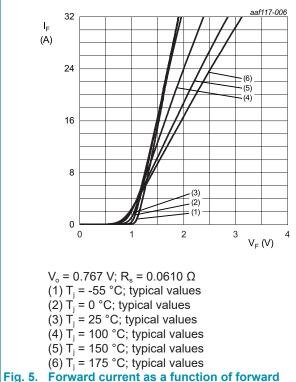
Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	with heatsink compound; Fig. 4	-	1	1.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W





## **10. Characteristics**

Fable 7. Cl	haracteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V <sub>F</sub>	forward current	I <sub>F</sub> = 16 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>	-	1.5	1.7	V
		I <sub>F</sub> = 16 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>	-	1.8	2.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 650 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>	-	-	100	μA
		V <sub>R</sub> = 650 V; T <sub>j</sub> = 150 °C; <u>Fig. 6</u>	-	-	400	μA
Dynamic	characteristics	· · · ·				
Q <sub>r</sub>	recovered charge	$I_{\rm F} = 16 \text{ A}; \text{ V}_{\rm R} = 400 \text{ V}; \text{ d}I_{\rm F}/\text{d}t = 500 \text{ A}/\mu\text{s}; \\ T_{\rm j} = 25 \text{ °C}; \frac{\text{Fig. 7}}{2}$	-	26	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C	-	534	-	pF
		f = 1 MHz; V <sub>R</sub> = 300 V; T <sub>j</sub> = 25 °C	-	75	-	pF
		f = 1 MHz; V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	73	-	pF
E <sub>as</sub>	non-repetitive	I <sub>R</sub> = 6.9 A; L = 5 mH; T <sub>j(init)</sub> = 25 °C	120	-	-	mJ
	avalanche energy					



voltage; typical values

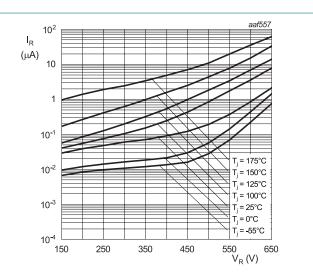
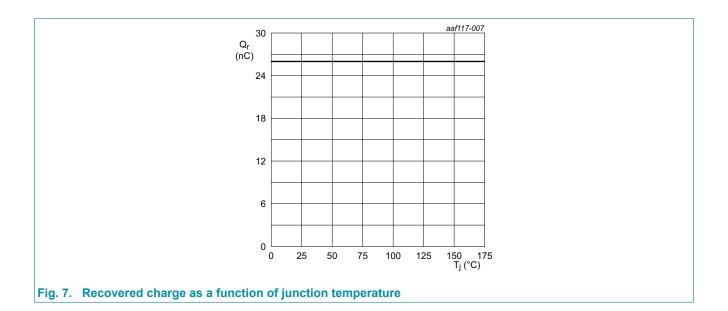
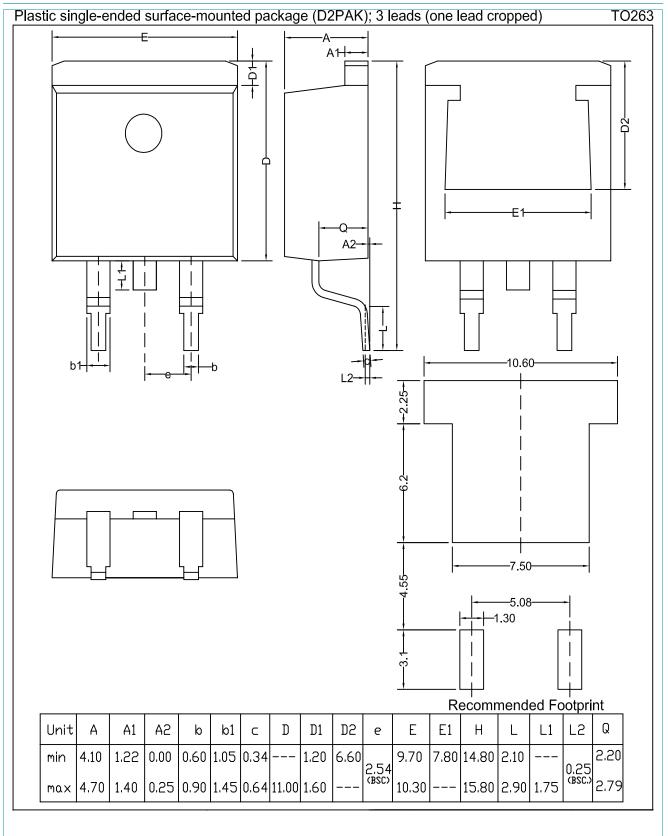


Fig. 6. Reverse leakage current as a function of reverse voltage; typical value

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## **11. Package outline**



NXPSC16650B Product data sheet

### NXPSC16650B Silicon Carbide Diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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